

SN54LV74, SN74LV74 DUAL POSITIVE-EDGE-TRIGGERED D-TYPE FLIP-FLOPS

SCLS189C – FEBRUARY 1993 – REVISED APRIL 1996

- **EPIC™ (Enhanced-Performance Implanted CMOS) 2- μ Process**
- **Typical V_{OLP} (Output Ground Bounce) < 0.8 V at V_{CC} , $T_A = 25^\circ\text{C}$**
- **Typical V_{OHV} (Output V_{OH} Undershoot) > 2 V at V_{CC} , $T_A = 25^\circ\text{C}$**
- **ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)**
- **Latch-Up Performance Exceeds 250 mA Per JEDEC Standard JESD-17**
- **Package Options Include Plastic Small-Outline (D), Shrink Small-Outline (DB), Thin Shrink Small-Outline (PW), Ceramic Flat (W) Packages, Chip Carriers (FK), and (J) 300-mil DIPs**

description

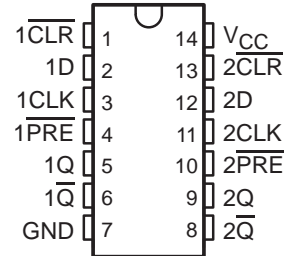
These dual positive-edge-triggered D-type flip-flops are designed for 2.7-V to 5.5-V V_{CC} operation.

A low level at the preset ($\overline{\text{PRE}}$) or clear ($\overline{\text{CLR}}$) inputs sets or resets the outputs regardless of the levels of the other inputs. When $\overline{\text{PRE}}$ and $\overline{\text{CLR}}$ are inactive (high), data at the data (D) inputs meeting the setup-time requirements is transferred to the outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a voltage level and is not directly related to the rise time of the clock pulse. Following the hold-time interval, data at the D input can be changed without affecting the levels at the outputs.

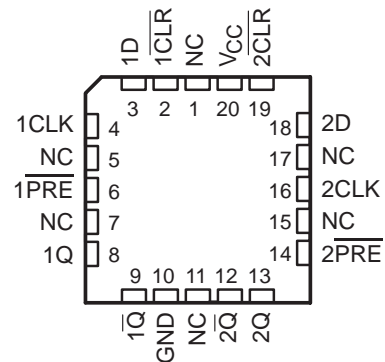
The SN74LV74 is available in TI's shrink small-outline package (DB), which provides the same I/O pin count and functionality of standard small-outline packages in less than half the printed-circuit-board area.

The SN54LV74 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74LV74 is characterized for operation from -40°C to 85°C .

SN54LV74 . . . J OR W PACKAGE
SN74LV74 . . . D, DP, OR PW PACKAGE
(TOP VIEW)



SN54LV74 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection



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**TEXAS
INSTRUMENTS**

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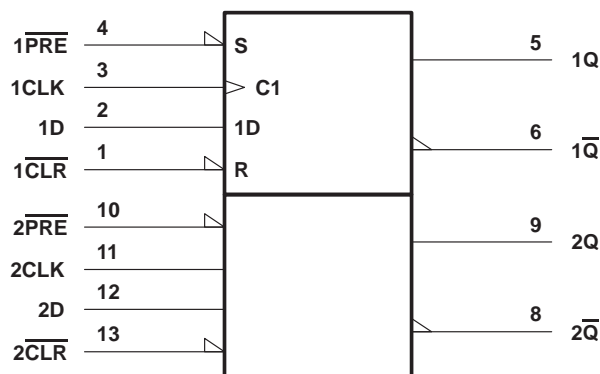
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FUNCTION TABLE

INPUTS				OUTPUTS	
$\overline{\text{PRE}}$	$\overline{\text{CLR}}$	CLK	D	Q	$\overline{\text{Q}}$
L	H	X	X	H	L
H	L	X	X	L	H
L	L	X	X	H [†]	H [†]
H	H	↑	H	H	L
H	H	↑	L	L	H
H	H	L	X	Q ₀	$\overline{\text{Q}}_0$

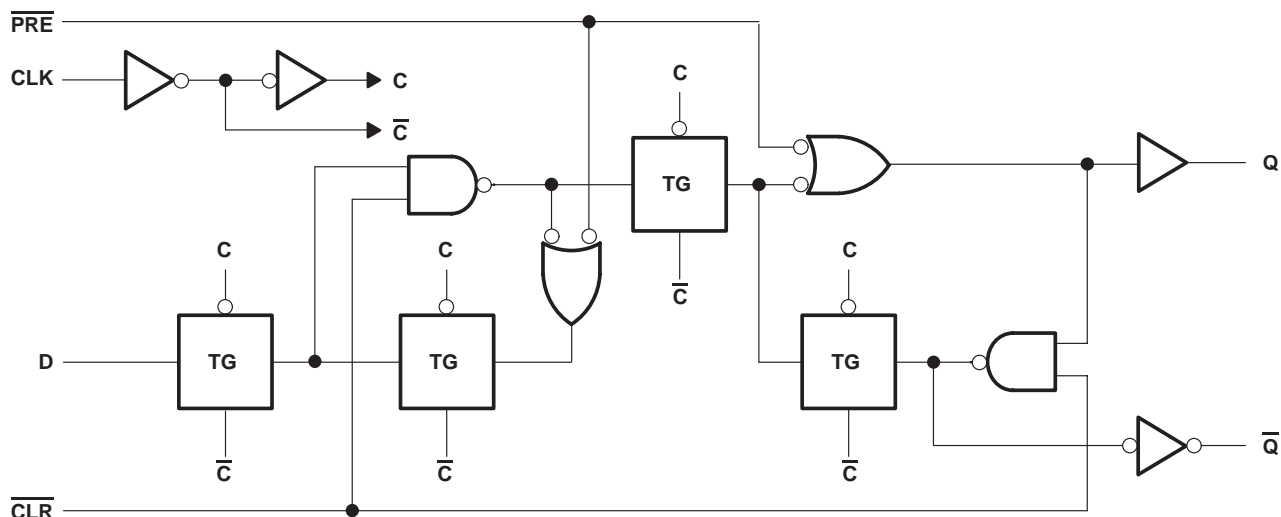
† This configuration is nonstable; that is, it does not persist when $\overline{\text{PRE}}$ or $\overline{\text{CLR}}$ returns to its inactive (high) level.

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, DB, J, PW, and W packages.

logic diagram, each flip-flop (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	–0.5 V to 7 V
Input voltage range, V_I (see Note 1)	–0.5 V to $V_{CC} + 0.5$ V
Output voltage range, V_O (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	±20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±25 mA
Continuous current through V_{CC} or GND	±50 mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 3): D package	1.25 W
DB or PW package	0.5 W
Storage temperature range, T_{stg}	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 2. This value is limited to 7 V maximum.
 3. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

recommended operating conditions (see Note 4)

		SN54LV74		SN74LV74		UNIT UNIT
		MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage	2.7	5.5	2.7	5.5	V
V_{IH}	High-level input voltage	$V_{CC} = 2.7$ V to 3.6 V		2		V
		$V_{CC} = 4.5$ V to 5.5 V		3.15		
V_{IL}	Low-level input voltage	$V_{CC} = 2.7$ V to 3.6 V		0.8		V
		$V_{CC} = 4.5$ V to 5.5 V		1.65		
V_I	Input voltage	0	V_{CC}	0	V_{CC}	V
V_O	Output voltage	0	V_{CC}	0	V_{CC}	V
I_{OH}	High-level output current	$V_{CC} = 2.7$ V to 3.6 V		–6		mA
		$V_{CC} = 4.5$ V to 5.5 V		–12		
I_{OL}	Low-level output current	$V_{CC} = 2.7$ V to 3.6 V		6		mA
		$V_{CC} = 4.5$ V to 5.5 V		12		
$\Delta t/\Delta v$	Input transition rise or fall rate	0	100	0	100	ns/V
T_A	Operating free-air temperature	–55	125	–40	85	°C

NOTE 4: Unused inputs must be held high or low to prevent them from floating.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		V _{CC} †	SN54LV74			SN74LV74			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	
V _{OH}	I _{OH} = -100 μA		MIN to MAX	V _{CC} - 0.2			V _{CC} - 0.2			V
	I _{OH} = -6 mA		3 V	2.4			2.4			
	I _{OH} = -12 mA		4.5 V	3.6			3.6			
V _{OL}	I _{OL} = 100 μA		MIN to MAX	0.2			0.2			V
	I _{OL} = 6 mA		3 V	0.4			0.4			
	I _{OL} = 12 mA		4.5 V	0.55			0.55			
I _I	V _I = V _{CC} or GND		3.6 V	±1			±1			μA
			5.5 V	±1			±1			
I _{CC}	V _I = V _{CC} or GND	I _O = 0	3.6 V	20			20			μA
			5.5 V	20			20			
ΔI _{CC}	One input at V _{CC} - 0.6 V	Other inputs at V _{CC} or GND	3 V to 3.6 V			500			μA	
C _i	V _I = V _{CC} or GND		3.3 V	2.5			2.5			pF
			5 V	3			3			

† For conditions shown as MIN or MAX, use the appropriate values under recommended operating conditions.

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

			SN54LV74						UNIT
			V _{CC} = 5 V ± 0.5 V		V _{CC} = 3.3 V ± 0.3 V		V _{CC} = 2.7 V		
			MIN	MAX	MIN	MAX	MIN	MAX	
f _{clock}	Clock frequency		0	70	0	60	0	50	ns
t _w	Pulse duration, LE high	PRE or CLR low	15		20		25		ns
		CLK high or low	15		20		25		
t _{su}	Setup time, data before CLK↑	Data	6		8		12		ns
		PRE or CLR inactive	5		6		8		
t _h	Hold time, data after CLK↑		3		3		3		ns

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

			SN74LV74						UNIT
			V _{CC} = 5 V ± 0.5 V		V _{CC} = 3.3 V ± 0.3 V		V _{CC} = 2.7 V		
			MIN	MAX	MIN	MAX	MIN	MAX	
f _{clock}	Clock frequency		0	70	0	60	0	50	ns
t _w	Pulse duration, LE high	PRE or CLR low	15		20		25		ns
		CLK high or low	15		20		25		
t _{su}	Setup time, data before CLK↑	Data	6		8		12		ns
		PRE or CLR inactive	5		6		8		
t _h	Hold time, data after CLK↑		3		3		3		ns

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switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54LV74						UNIT		
			$V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$			$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$				$V_{CC} = 2.7 \text{ V}$	
			MIN	TYP	MAX	MIN	TYP	MAX		MIN	MAX
f_{max}			70	100		60	90		50	MHz	
t_{pd}	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$	Q or \overline{Q}		11	19		18	27		34	ns
	CLK			10	17		17	26		28	

switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN74LV74						UNIT		
			$V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$			$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$				$V_{CC} = 2.7 \text{ V}$	
			MIN	TYP	MAX	MIN	TYP	MAX		MIN	MAX
f_{max}			70	100		60	90		50	MHz	
t_{pd}	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$	Q or \overline{Q}		11	19		18	27		34	ns
	CLK			10	17		17	26		28	

operating characteristics, $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	V_{CC}	TYP	UNIT
C_{pd}	Power dissipation capacitance per flip-flop	$C_L = 50 \text{ pF}$, $f = 10 \text{ MHz}$	3.3 V	32	pF
			5 V	68	

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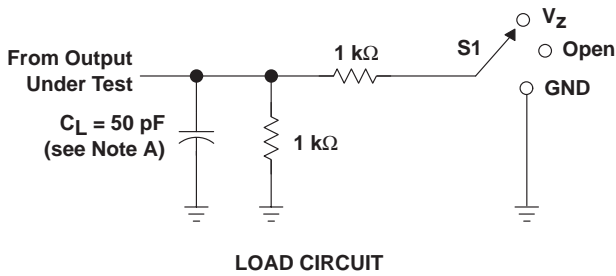


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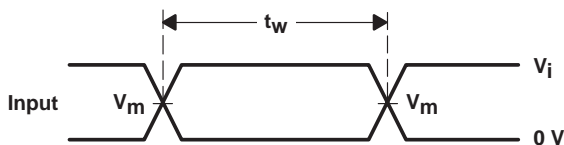
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PARAMETER MEASUREMENT INFORMATION

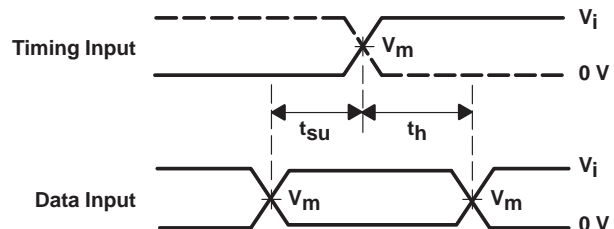


TEST	S1
t _{PLH} /t _{PHL}	Open
t _{PLZ} /t _{PZL}	V _Z
t _{PHZ} /t _{PZH}	GND

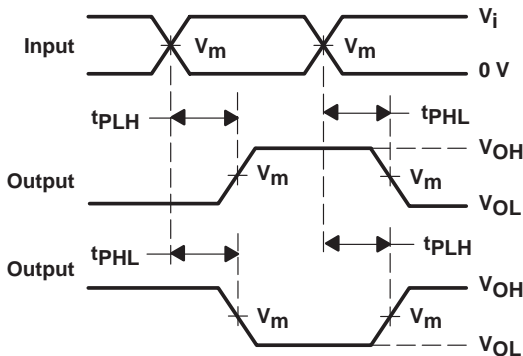
WAVEFORM CONDITION	V _{CC} = 4.5 V to 5.5 V	V _{CC} = 2.7 V to 3.6 V
V _m	0.5 × V _{CC}	1.5 V
V _i	V _{CC}	2.7 V
V _Z	2 × V _{CC}	6 V



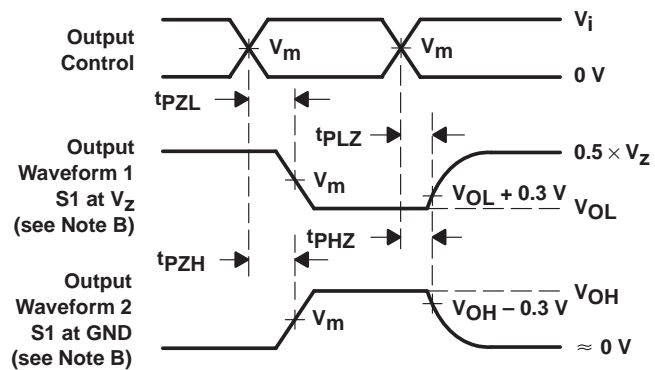
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z_O = 50 Ω, t_r ≤ 2.5 ns, t_f ≤ 2.5 ns.
 D. The outputs are measured one at a time with one transition per measurement.
 E. t_{PLZ} and t_{PHZ} are the same as t_{dis}.
 F. t_{PZL} and t_{PZH} are the same as t_{en}.
 G. t_{PLH} and t_{PHL} are the same as t_{pd}.

Figure 1. Load Circuit and Voltage Waveforms

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